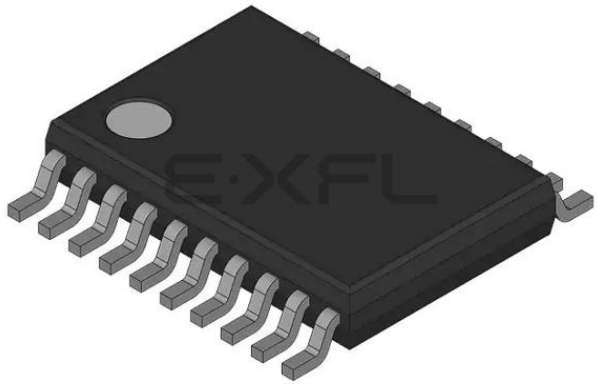

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Details	
Product Status	Active
Core Processor	S08
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	16
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-TSSOP
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Chapter 2
Pins and Connections

This section describes signals that connect to package pins. It includes pinout diagrams, recommended system connections, and detailed discussions of signals.

2.1 Device Pin Assignment

This section describes pin assignments for the MC9S08EL32 Series and MC9S08SL16 Series devices. Not all features are available in all devices. See Table 1-1 for details.

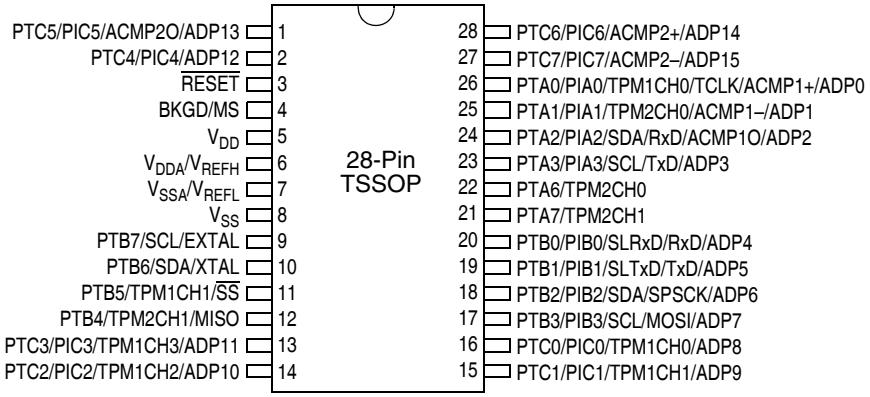


Figure 2-1. 28-Pin TSSOP

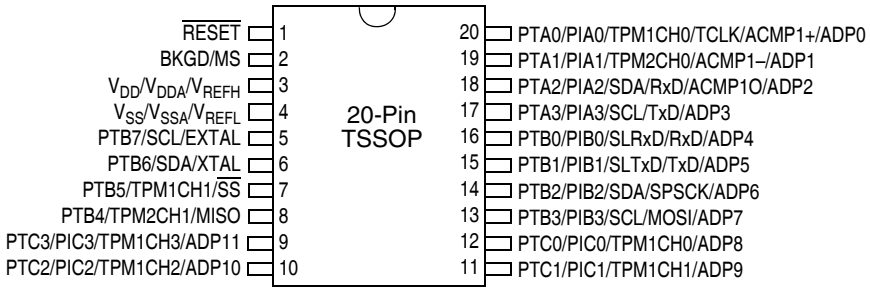


Figure 2-2. 20-Pin TSSOP

Table 3-1 shows all of the control bits that affect stop mode selection and the mode selected under various conditions. The selected mode is entered following the execution of a STOP instruction.

Table 3-1. Stop Mode Selection

STOPE	ENBDM [1]	LVDE	LVDSE	PPDC	Stop Mode
0	x	x		x	Stop modes disabled; illegal opcode reset if STOP instruction executed
1	1	x		x	Stop3 with BDM enabled [2]
1	0	Both bits must be 1		0	Stop3 with voltage regulator active
1	0	Either bit a 0		0	Stop3
1	0	Either bit a 0		1	Stop2

1 ENBDM is located in the BDCSCR, which is only accessible through BDC commands, see Section 17.4.1.1, "BDC Status and Control Register (BDCSCR)".

2 When in Stop3 mode with BDM enabled, The S_{IDD} will be near R_{IDD} levels because internal clocks are enabled.

3.6.1 Stop3 Mode

Stop3 mode is entered by executing a STOP instruction under the conditions as shown in Table 3-1. The states of all of the internal registers and logic, RAM contents, and I/O pin states are maintained.

Exit from stop3 is done by asserting $\overline{\text{RESET}}$, or an asynchronous interrupt pin. The asynchronous interrupt pins are PIA0-PIA3, PIB0 -PIB3, and PIC0-PIC7. Exit from stop3 can also be done by the low-voltage detection (LVD) reset, the low-voltage warning (LVW) interrupt, the ADC conversion complete interrupt, the analog comparator (ACMP) interrupt, the real-time counter (RTC) interrupt, the SLIC wake-up interrupt, or the SCI receiver interrupt.

If stop3 is exited by means of the $\overline{\text{RESET}}$ pin, the MCU will be reset and operation will resume after fetching the reset vector. Exit by means of an asynchronous interrupt, analog comparator interrupt, or the real-time interrupt will result in the MCU fetching the appropriate interrupt vector.

3.6.1.1 LVD Enabled in Stop Mode

The LVD system is capable of generating either an interrupt or a reset when the supply voltage drops below the LVD voltage. If the LVD is enabled in stop (LVDE and LVDSE bits in SPMSC1 both set) at the time the CPU executes a STOP instruction, then the voltage regulator remains active during stop mode.

For the ADC to operate the LVD must be left enabled when entering stop3.

3.6.1.2 Active BDM Enabled in Stop Mode

Entry into the active background mode from run mode is enabled if ENBDM in BDCSCR is set. This register is described in Chapter 17, "Development Support." If ENBDM is set when the CPU executes a STOP instruction, the system clocks to the background debug logic remain active when the MCU enters stop mode. Because of this, background debug communication remains possible. In addition, the voltage regulator does not enter its low-power standby state but maintains full internal regulation.

Table 4-6. FCDIV Register Field Descriptions

Field	Description
7 DIVLD	**Divisor Loaded Status Flag** — When set, this read-only status flag indicates that the FCDIV register has been written since reset. Reset clears this bit and the first write to this register causes this bit to become set regardless of the data written. 0 FCDIV has not been written since reset; erase and program operations disabled for FLASH and EEPROM. 1 FCDIV has been written since reset; erase and program operations enabled for FLASH and EEPROM.
6 PRDIV8	**Prescale (Divide) FLASH and EEPROM Clock by 8** 0 Clock input to the FLASH and EEPROM clock divider is the bus rate clock. 1 Clock input to the FLASH and EEPROM clock divider is the bus rate clock divided by 8.
5:0 DIV	**Divisor for FLASH and EEPROM Clock Divider** — The FLASH and EEPROM clock divider divides the bus rate clock (or the bus rate clock divided by 8 if PRDIV8 = 1) by the value in the 6-bit DIV field plus one. The resulting frequency of the internal FLASH and EEPROM clock must fall within the range of 200 kHz to 150 kHz for proper FLASH operations. Program/Erase timing pulses are one cycle of this internal FLASH and EEPROM clock which corresponds to a range of 5 μs to 6.7 μs. The automated programming logic uses an integer number of these pulses to complete an erase or program operation. See Equation 4-1 and Equation 4-2.

$$\text{if PRDIV8 = 0 — } f_{FCLK} = f_{Bus} \div (DIV + 1) \qquad \textit{Eqn. 4-1}$$

$$\text{if PRDIV8 = 1 — } f_{FCLK} = f_{Bus} \div (8 \times (DIV + 1)) \qquad \textit{Eqn. 4-2}$$

Table 4-7 shows the appropriate values for PRDIV8 and DIV for selected bus frequencies.

Table 4-7. FLASH and EEPROM clock divider Settings

f_{Bus}	PRDIV8 (Binary)	DIV (Decimal)	f_{FCLK}	Program/Erase Timing Pulse (5 μs Min, 6.7 μs Max)
20 MHz	1	12	192.3 kHz	5.2 μs
10 MHz	0	49	200 kHz	5 μs
8 MHz	0	39	200 kHz	5 μs
4 MHz	0	19	200 kHz	5 μs
2 MHz	0	9	200 kHz	5 μs
1 MHz	0	4	200 kHz	5 μs
200 kHz	0	0	200 kHz	5 μs
150 kHz	0	0	150 kHz	6.7 μs

5.7.5 System Device Identification Register (SDIDH, SDIDL)

These high page read-only registers are included so host development systems can identify the HCS08 derivative and revision number. This allows the development software to recognize where specific memory blocks, registers, and control bits are located in a target MCU.

	7	6	5	4	3	2	1	0
R					ID11	ID10	ID9	ID8
W								
Reset:	0[1]	0[1]	0[1]	0[1]	0	0	0	0

= Unimplemented or Reserved

[1] The revision number that is hard coded into these bits reflects the current silicon revision level.

Figure 5-6. System Device Identification Register — High (SDIDH)

Table 5-7. SDIDH Register Field Descriptions

Field	Description
3:0 ID[11:8]	**Part Identification Number** — Each derivative in the HCS08 Family has a unique identification number. The MC9S08EL32 is hard coded to the value 0x013. See also ID bits in Table 5-8.

	7	6	5	4	3	2	1	0
R	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
W								
Reset:	0	0	0	1	0	0	1	1

= Unimplemented or Reserved

Figure 5-7. System Device Identification Register — Low (SDIDL)

Table 5-8. SDIDL Register Field Descriptions

Field	Description
7:0 ID[7:0]	**Part Identification Number** — Each derivative in the HCS08 Family has a unique identification number. The MC9S08EL32 is hard coded to the value 0x013. See also ID bits in Table 5-7.

Chapter 7
Central Processor Unit (S08CPUV3)

7.1 Introduction

This section provides summary information about the registers, addressing modes, and instruction set of the CPU of the HCS08 Family. For a more detailed discussion, refer to the *HCS08 Family Reference Manual, volume 1,* Freescale Semiconductor document order number HCS08RMV1/D.

The HCS08 CPU is fully source- and object-code-compatible with the M68HC08 CPU. Several instructions and enhanced addressing modes were added to improve C compiler efficiency and to support a new background debug system which replaces the monitor mode of earlier M68HC08 microcontrollers (MCU).

7.1.1 Features

Features of the HCS08 CPU include:

- Object code fully upward-compatible with M68HC05 and M68HC08 Families
- All registers and memory are mapped to a single 64-Kbyte address space
- 16-bit stack pointer (any size stack anywhere in 64-Kbyte address space)
- 16-bit index register (H:X) with powerful indexed addressing modes
- 8-bit accumulator (A)
- Many instructions treat X as a second general-purpose 8-bit register
- Seven addressing modes:
  - Inherent — Operands in internal registers
  - Relative — 8-bit signed offset to branch destination
  - Immediate — Operand in next object code byte(s)
  - Direct — Operand in memory at 0x0000–0x00FF
  - Extended — Operand anywhere in 64-Kbyte address space
  - Indexed relative to H:X — Five submodes including auto increment
  - Indexed relative to SP — Improves C efficiency dramatically
- Memory-to-memory data move instructions with four address mode combinations
- Overflow, half-carry, negative, zero, and carry condition codes support conditional branching on the results of signed, unsigned, and binary-coded decimal (BCD) operations
- Efficient bit manipulation instructions
- Fast 8-bit by 8-bit multiply and 16-bit by 8-bit divide instructions
- STOP and WAIT instructions to invoke low-power operating modes

7.3 Addressing Modes

Addressing modes define the way the CPU accesses operands and data. In the HCS08, all memory, status and control registers, and input/output (I/O) ports share a single 64-Kbyte linear address space so a 16-bit binary address can uniquely identify any memory location. This arrangement means that the same instructions that access variables in RAM can also be used to access I/O and control registers or nonvolatile program space.

Some instructions use more than one addressing mode. For instance, move instructions use one addressing mode to specify the source operand and a second addressing mode to specify the destination address. Instructions such as BRCLR, BRSET, CBEQ, and DBNZ use one addressing mode to specify the location of an operand for a test and then use relative addressing mode to specify the branch destination address when the tested condition is true. For BRCLR, BRSET, CBEQ, and DBNZ, the addressing mode listed in the instruction set tables is the addressing mode needed to access the operand to be tested, and relative addressing mode is implied for the branch destination.

7.3.1 Inherent Addressing Mode (INH)

In this addressing mode, operands needed to complete the instruction (if any) are located within CPU registers so the CPU does not need to access memory to get any operands.

7.3.2 Relative Addressing Mode (REL)

Relative addressing mode is used to specify the destination location for branch instructions. A signed 8-bit offset value is located in the memory location immediately following the opcode. During execution, if the branch condition is true, the signed offset is sign-extended to a 16-bit value and is added to the current contents of the program counter, which causes program execution to continue at the branch destination address.

7.3.3 Immediate Addressing Mode (IMM)

In immediate addressing mode, the operand needed to complete the instruction is included in the object code immediately following the instruction opcode in memory. In the case of a 16-bit immediate operand, the high-order byte is located in the next memory location after the opcode, and the low-order byte is located in the next memory location after that.

7.3.4 Direct Addressing Mode (DIR)

In direct addressing mode, the instruction includes the low-order eight bits of an address in the direct page (0x0000–0x00FF). During execution a 16-bit address is formed by concatenating an implied 0x00 for the high-order half of the address and the direct address from the instruction to get the 16-bit address where the desired operand is located. This is faster and more memory efficient than specifying a complete 16-bit address for the operand.

7.3.6.7 SP-Relative, 16-Bit Offset (SP2)

This variation of indexed addressing uses the 16-bit value in the stack pointer (SP) plus a 16-bit offset included in the instruction as the address of the operand needed to complete the instruction.

7.4 Special Operations

The CPU performs a few special operations that are similar to instructions but do not have opcodes like other CPU instructions. In addition, a few instructions such as STOP and WAIT directly affect other MCU circuitry. This section provides additional information about these operations.

7.4.1 Reset Sequence

Reset can be caused by a power-on-reset (POR) event, internal conditions such as the COP (computer operating properly) watchdog, or by assertion of an external active-low reset pin. When a reset event occurs, the CPU immediately stops whatever it is doing (the MCU does not wait for an instruction boundary before responding to a reset event). For a more detailed discussion about how the MCU recognizes resets and determines the source, refer to the Resets, Interrupts, and System Configuration chapter.

The reset event is considered concluded when the sequence to determine whether the reset came from an internal source is done and when the reset pin is no longer asserted. At the conclusion of a reset event, the CPU performs a 6-cycle sequence to fetch the reset vector from 0xFFFE and 0xFFFF and to fill the instruction queue in preparation for execution of the first program instruction.

7.4.2 Interrupt Sequence

When an interrupt is requested, the CPU completes the current instruction before responding to the interrupt. At this point, the program counter is pointing at the start of the next instruction, which is where the CPU should return after servicing the interrupt. The CPU responds to an interrupt by performing the same sequence of operations as for a software interrupt (SWI) instruction, except the address used for the vector fetch is determined by the highest priority interrupt that is pending when the interrupt sequence started.

The CPU sequence for an interrupt is:

1. Store the contents of PCL, PCH, X, A, and CCR on the stack, in that order.
2. Set the I bit in the CCR.
3. Fetch the high-order half of the interrupt vector.
4. Fetch the low-order half of the interrupt vector.
5. Delay for one free bus cycle.
6. Fetch three bytes of program information starting at the address indicated by the interrupt vector to fill the instruction queue in preparation for execution of the first instruction in the interrupt service routine.

After the CCR contents are pushed onto the stack, the I bit in the CCR is set to prevent other interrupts while in the interrupt service routine. Although it is possible to clear the I bit with an instruction in the

Table 7-2. Instruction Set Summary (Sheet 3 of 9)

Source Form	Operation	Address Mode	Object Code	Cycles	Cyc-by-Cyc Details	Affect on CCR	
						V 1 1 H	I N Z C
BLE *rel*	Branch if Less Than or Equal To (if Z | (N ⊕ V) = 1) (Signed)	REL	93 rr	3	ppp	– 1 1 –	– – – –
BLO *rel*	Branch if Lower (if C = 1) (Same as BCS)	REL	25 rr	3	ppp	– 1 1 –	– – – –
BLS *rel*	Branch if Lower or Same (if C | Z = 1)	REL	23 rr	3	ppp	– 1 1 –	– – – –
BLT *rel*	Branch if Less Than (if N ⊕ V = 1) (Signed)	REL	91 rr	3	ppp	– 1 1 –	– – – –
BMC *rel*	Branch if Interrupt Mask Clear (if I = 0)	REL	2C rr	3	ppp	– 1 1 –	– – – –
BMI *rel*	Branch if Minus (if N = 1)	REL	2B rr	3	ppp	– 1 1 –	– – – –
BMS *rel*	Branch if Interrupt Mask Set (if I = 1)	REL	2D rr	3	ppp	– 1 1 –	– – – –
BNE *rel*	Branch if Not Equal (if Z = 0)	REL	26 rr	3	ppp	– 1 1 –	– – – –
BPL *rel*	Branch if Plus (if N = 0)	REL	2A rr	3	ppp	– 1 1 –	– – – –
BRA *rel*	Branch Always (if I = 1)	REL	20 rr	3	ppp	– 1 1 –	– – – –
BRCLR *n,opr8a,rel*	Branch if Bit *n* in Memory Clear (if (Mn) = 0)	DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7)	01 dd rr 03 dd rr 05 dd rr 07 dd rr 09 dd rr 0B dd rr 0D dd rr 0F dd rr	5 5 5 5 5 5 5 5	rpppp rpppp rpppp rpppp rpppp rpppp rpppp rpppp	– 1 1 –	– – – ↕
BRN *rel*	Branch Never (if I = 0)	REL	21 rr	3	ppp	– 1 1 –	– – – –
BRSET *n,opr8a,rel*	Branch if Bit *n* in Memory Set (if (Mn) = 1)	DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7)	00 dd rr 02 dd rr 04 dd rr 06 dd rr 08 dd rr 0A dd rr 0C dd rr 0E dd rr	5 5 5 5 5 5 5 5	rpppp rpppp rpppp rpppp rpppp rpppp rpppp rpppp	– 1 1 –	– – – ↕
BSET *n,opr8a*	Set Bit *n* in Memory (Mn ← 1)	DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7)	10 dd 12 dd 14 dd 16 dd 18 dd 1A dd 1C dd 1E dd	5 5 5 5 5 5 5 5	rfwpp rfwpp rfwpp rfwpp rfwpp rfwpp rfwpp rfwpp	– 1 1 –	– – – –
BSR *rel*	Branch to Subroutine PC ← (PC) + $0002 push (PCL); SP ← (SP) – $0001 push (PCH); SP ← (SP) – $0001 PC ← (PC) + *rel*	REL	AD rr	5	ssppp	– 1 1 –	– – – –
CBEQ *opr8a,rel* CBEQA *#opr8i,rel* CBEQX *#opr8i,rel* CBEQ *oprx8*,X+,*rel* CBEQ ,X+,*rel* CBEQ *oprx8*,SP,*rel*	Compare and... Branch if (A) = (M) Branch if (A) = (M) Branch if (X) = (M) Branch if (A) = (M) Branch if (A) = (M) Branch if (A) = (M)	DIR IMM IMM IX1+ IX+ SP1	31 dd rr 41 ii rr 51 ii rr 61 ff rr 71 rr 9E 61 ff rr	5 4 4 5 5 6	rpppp pppp pppp rpppp rfppp prpppp	– 1 1 –	– – – –

9.1.3 Features

The ACMP has the following features:

- Full rail to rail supply operation.
- Selectable interrupt on rising edge, falling edge, or either rising or falling edges of comparator output.
- Option to compare to fixed internal bandgap reference voltage.
- Option to allow comparator output to be visible on a pin, ACMPxO.
- Can operate in stop3 mode

9.1.4 Modes of Operation

This section defines the ACMP operation in wait, stop and background debug modes.

9.1.4.1 ACMP in Wait Mode

The ACMP continues to run in wait mode if enabled before executing the WAIT instruction. Therefore, the ACMP can be used to bring the MCU out of wait mode if the ACMP interrupt, ACIE is enabled. For lowest possible current consumption, the ACMP should be disabled by software if not required as an interrupt source during wait mode.

9.1.4.2 ACMP in Stop Modes

9.1.4.2.1 Stop3 Mode Operation

The ACMP continues to operate in Stop3 mode if enabled and compare operation remains active. If ACOPE is enabled, comparator output operates as in the normal operating mode and comparator output is placed onto the external pin. The MCU is brought out of stop when a compare event occurs and ACIE is enabled; ACF flag sets accordingly.

If stop is exited with a reset, the ACMP will be put into its reset state.

9.1.4.2.2 Stop2 and Stop1 Mode Operation

During either Stop2 and Stop1 mode, the ACMP module will be fully powered down. Upon wake-up from Stop2 or Stop1 mode, the ACMP module will be in the reset state.

9.1.4.3 ACMP in Active Background Mode

When the microcontroller is in active background mode, the ACMP will continue to operate normally.

9.2 External Signal Description

The ACMP has two analog input pins, ACMPx+ and ACMPx- and one digital output pin ACMPxO. Each of these pins can accept an input voltage that varies across the full operating voltage range of the MCU. As shown in Figure 9-2, the ACMPx- pin is connected to the inverting input of the comparator, and the ACMPx+ pin is connected to the comparator non-inverting input if ACBGS is a 0. As shown in Figure 9-2, the ACMPxO pin can be enabled to drive an external pin.

The signal properties of ACMP are shown in Table 9-2.

Table 9-2. Signal Properties

Signal	Function	I/O
ACMPx-	Inverting analog input to the ACMP. (Minus input)	I
ACMPx+	Non-inverting analog input to the ACMP. (Positive input)	I
ACMPxO	Digital output of the ACMP.	O

9.3 Memory Map

9.3.1 Register Descriptions

The ACMP includes one register:

- An 8-bit status and control register

Refer to the direct-page register summary in the memory section of this data sheet for the absolute address assignments for all ACMP registers.This section refers to registers and control bits only by their names .

Some MCUs may have more than one ACMP, so register names include placeholder characters to identify which ACMP is being referenced.

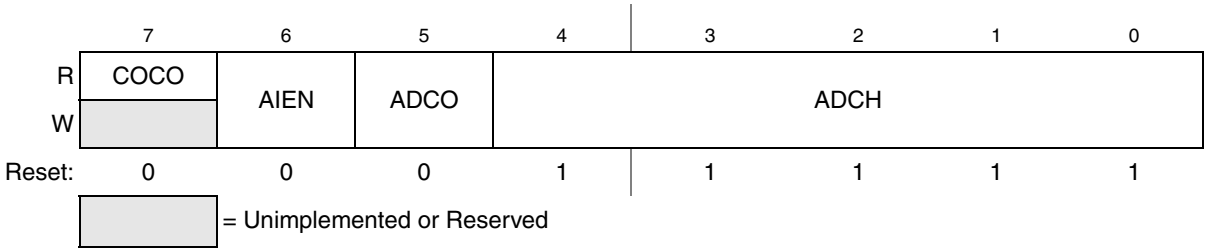


Figure 10-3. Status and Control Register (ADCSC1)

Table 10-3. ADCSC1 Register Field Descriptions

Field	Description
7 COCO	**Conversion Complete Flag** — The COCO flag is a read-only bit which is set each time a conversion is completed when the compare function is disabled (ACFE = 0). When the compare function is enabled (ACFE = 1) the COCO flag is set upon completion of a conversion only if the compare result is true. This bit is cleared whenever ADCSC1 is written or whenever ADCRL is read. 0 Conversion not completed 1 Conversion completed
6 AIEN	**Interrupt Enable** — AIEN is used to enable conversion complete interrupts. When COCO becomes set while AIEN is high, an interrupt is asserted. 0 Conversion complete interrupt disabled 1 Conversion complete interrupt enabled
5 ADCO	**Continuous Conversion Enable** — ADCO is used to enable continuous conversions. 0 One conversion following a write to the ADCSC1 when software triggered operation is selected, or one conversion following assertion of ADHWT when hardware triggered operation is selected. 1 Continuous conversions initiated following a write to ADCSC1 when software triggered operation is selected. Continuous conversions are initiated by an ADHWT event when hardware triggered operation is selected.
4:0 ADCH	**Input Channel Select** — The ADCH bits form a 5-bit field which is used to select one of the input channels. The input channels are detailed in Figure 10-4. The successive approximation converter subsystem is turned off when the channel select bits are all set to 1. This feature allows for explicit disabling of the ADC and isolation of the input channel from all sources. Terminating continuous conversions this way will prevent an additional, single conversion from being performed. It is not necessary to set the channel select bits to all 1s to place the ADC in a low-power state when continuous conversions are not enabled because the module automatically enters a low-power state when a conversion completes.

Figure 10-4. Input Channel Select

ADCH	Input Select
00000	AD0
00001	AD1
00010	AD2
00011	AD3
00100	AD4
00101	AD5
00110	AD6
00111	AD7

ADCH	Input Select
10000	AD16
10001	AD17
10010	AD18
10011	AD19
10100	AD20
10101	AD21
10110	AD22
10111	AD23

Table 12-2. SLCC2 Field Descriptions

Field	Description
6:4 RXFP	**Receive Filter Prescaler** — These bits configure the effective filter width for the digital receive filter circuit. The RXFP bits control the maximum number of SLIC clock counts required for the filter to change state, which determines the total maximum filter delay. Any pulse which is smaller than the maximum filter delay value will be rejected by the filter and ignored as noise. For this reason, the user must choose the prescaler value appropriately to ensure that all valid message traffic is able to pass the filter for the desired bit rate. For more details about setting up the digital receive filter, please refer to Section 12.6.18, “Digital Receive Filter.” The frequency of the SLIC clock must be between 2 MHz and 20 MHz, factoring in worst case possible numbers due to untrimmed process variations, as well as temperature and voltage variations in oscillator frequency. This will guarantee greater than 1.5% accuracy for all LIN messages from 1–20 kbps. The faster this input clock is, the greater the resulting accuracy and the higher the possible bit rates at which the SLIC can send and receive. In LIN systems, the bit rates will not exceed 20 kbps; however, the SLIC module is capable of much higher speeds without any configuration changes, for cases such as high-speed downloads for reprogramming of FLASH memory or diagnostics in a test environment where radiated emissions requirements are not as stringent. In these situations, the user may choose to run faster than the 20 kbps limit which is imposed by the LIN specification for EMC reasons. Details of how to calculate maximum bit rates and operate the SLIC above 20 kbps are detailed in .” Refer to Section 12.6.6, “SLIC Module Initialization Procedure,” for more information on when to set up this register. See Table 12-3.
3 SLCWCM	**SLIC Wait Clock Mode** — This write-once bit can only be written once out of MCU reset state and should be written before SLIC is first enabled. 0 SLIC clocks continue to run when the CPU is placed into wait mode so that the SLIC can receive messages and wakeup the CPU. 1 SLIC clocks stop when the CPU is placed into wait mode
2 BTM[1]	**UART Byte Transfer Mode** — Byte transmit mode bypasses the normal LIN message framing and checksum monitoring and allows the user to send and receive single bytes in a method similar to a half-duplex UART. When enabled, this mode reads the bit time register (SLCBT) value and assumes this is the value corresponding to the number of SLIC clock counts for one bit time to establish the desired UART bit rate. The user software must initialize this register prior to sending or receiving data, based on the input clock selection, prescaler stage choice, and desired bit rate. If this bit is cleared during a byte transmission, that byte transmission is halted immediately. BTM treats any data length in SLCDLC as one byte (DLC = 0x00) and disables the checksum circuitry so that CHKMOD has no effect. Refer to Section 12.6.16, “Byte Transfer Mode Operation,” for more detailed information about how to use this mode. BTM sets up the SLIC module to send and receive one byte at a time, with 8-bit data, no parity, and one stop bit (8-N-1). This is the most commonly used setup for UART communications and should work for most applications. This is fixed in the SLIC and is not configurable. 0 UART byte transfer mode disabled 1 UART byte transfer mode enabled
0 SLCE	**SLIC Module Enable** — Controls the clock to the SLIC module 0 SLIC module disabled 1 SLIC module enabled

[1] To guarantee timing, the user must ensure that the SLIC clock used allows the proper communications timing tolerances and therefore internal oscillator circuits might not be appropriate for use with BTM mode.

method was employed for this message frame. Refer to the LIN specification for more details on the calculations.

- **Byte Framing Error**
  This error comes from the standard UART definition for byte encoding and occurs when the STOP bit is sampled and reads back as a 090. STOP should always read as 1.

NOTE

A byte framing error can also be an indication that the number of data bytes received in a LIN message frame does not match the value written to the SLCDLC register. See Section 12.6.7, "Handling LIN Message Headers," for more details.

- **Identifier Received Successfully**
  This interrupt source indicates that a LIN identifier byte has been received with correct parity and is waiting in the LIN identifier buffer (SLCID). Upon reading this interrupt source from SLCSV, the user can then decode the identifier in software to determine the nature of the LIN message frame. To clear this source, SLCID must be read.
- **Identifier-Parity-Error**
  A parity error in the identifier (i.e., corrupted identifier) will be flagged. Typical LIN slave applications do not distinguish between an unknown but valid identifier, and a corrupted identifier. However, it is mandatory for all slave nodes to evaluate in case of a known identifier all eight bits of the ID-Field and distinguish between a known and a corrupted identifier. The received identifier value is reported in SLCID so that the user software can choose to acknowledge or ignore the parity error message. Once the ID parity error has been detected, the SLIC will begin looking for another LIN header and will not receive message data, even if it appears on the bus.
- **Wakeup**
  The wakeup interrupt source indicates that the SLIC module has entered SLIC run mode from SLIC stop mode.

12.3.5.2 Byte Transfer Mode Operation

When byte transfer mode is enabled (BTM = 1), many of the interrupt sources for the SLCSV no longer apply, as they are specific to LIN operations. Table 12-9 shows those interrupt sources which are applicable to BTM operations. The value of the SLCSV for each interrupt source remains the same, as well as the priority of the interrupt source.

Table 12-9. Interrupt Sources Summary (BTM = 1)

SLCSV	I3	I2	I1	I0	Interrupt Source	Priority
0x00	0	0	0	0	No Interrupts Pending	0 (Lowest)
0x0C	0	0	1	1	TX Message Buffer Empty	3
0x14	0	1	0	1	RX Data Buffer Full No Errors	5
0x18	0	1	1	0	Bit-Error	6
0x1C	0	1	1	1	Receiver Buffer Overrun	7

Chapter 15
Real-Time Counter (S08RTCV1)

15.1 Introduction

The RTC module consists of one 8-bit counter, one 8-bit comparator, several binary-based and decimal-based prescaler dividers, two clock sources, and one programmable periodic interrupt. This module can be used for time-of-day, calendar or any task scheduling functions. It can also serve as a cyclic wake up from low power modes without the need of external components.

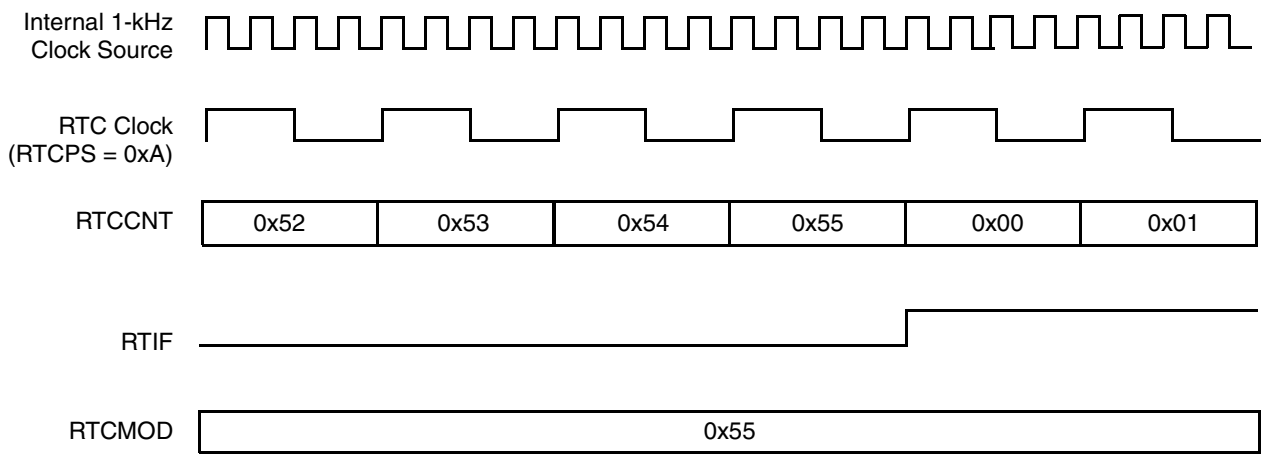


Figure 15-6. RTC Counter Overflow Example

In the example of Figure 15-6, the selected clock source is the 1-kHz internal oscillator clock source. The prescaler (RTCPS) is set to 0xA or divide-by-4. The modulo value in the RTCMOD register is set to 0x55. When the counter, RTCCNT, reaches the modulo value of 0x55, the counter overflows to 0x00 and continues counting. The real-time interrupt flag, RTIF, sets when the counter value changes from 0x55 to 0x00. A real-time interrupt is generated when RTIF is set, if RTIE is set.

15.5 Initialization/Application Information

This section provides example code to give some basic direction to a user on how to initialize and configure the RTC module. The example software is implemented in C language.

The example below shows how to implement time of day with the RTC using the 1-kHz clock source to achieve the lowest possible power consumption. Because the 1-kHz clock source is not as accurate as a crystal, software can be added for any adjustments. For accuracy without adjustments at the expense of additional power consumption, the external clock (ERCLK) or the internal clock (IRCLK) can be selected with appropriate prescaler and modulo values.

```
/* Initialize the elapsed time counters */
Seconds = 0;
Minutes = 0;
Hours = 0;
Days=0;

/* Configure RTC to interrupt every 1 second from 1-kHz clock source */
RTCMOD.byte = 0x00;
RTCSC.byte = 0x1F;

/*********************************************************************
Function Name : RTC_ISR
Notes : Interrupt service routine for RTC module.
*********************************************************************/
```

Table 16-8. TPM Clock Source Selection

CLKSB:CLKSA	TPM Clock Source to Prescaler Input
00	No clock selected (TPM counter disabled)
01	Bus rate clock
10	Fixed system clock
11	External source

The bus rate clock is the main system bus clock for the MCU. This clock source requires no synchronization because it is the clock that is used for all internal MCU activities including operation of the CPU and buses.

In MCUs that have no PLL and FLL or the PLL and FLL are not engaged, the fixed system clock source is the same as the bus-rate-clock source, and it does not go through a synchronizer. When a PLL or FLL is present and engaged, a synchronizer is required between the crystal divided-by two clock source and the timer counter so counter transitions will be properly aligned to bus-clock transitions. A synchronizer will be used at chip level to synchronize the crystal-related source clock to the bus clock.

The external clock source may be connected to any TPM channel pin. This clock source always has to pass through a synchronizer to assure that counter transitions are properly aligned to bus clock transitions. The bus-rate clock drives the synchronizer; therefore, to meet Nyquist criteria even with jitter, the frequency of the external clock source must not be faster than the bus rate divided-by four. With ideal clocks the external clock can be as fast as bus clock divided by four.

When the external clock source shares the TPM channel pin, this pin should not be used for other channel timing functions. For example, it would be ambiguous to configure channel 0 for input capture when the TPM channel 0 pin was also being used as the timer external clock source. (It is the user's responsibility to avoid such settings.) The TPM channel could still be used in output compare mode for software timing functions (pin controls set not to affect the TPM channel pin).

16.4.1.2 Counter Overflow and Modulo Reset

An interrupt flag and enable are associated with the 16-bit main counter. The flag (TOF) is a software-accessible indication that the timer counter has overflowed. The enable signal selects between software polling (TOIE=0) where no hardware interrupt is generated, or interrupt-driven operation (TOIE=1) where a static hardware interrupt is generated whenever the TOF flag is equal to one.

The conditions causing TOF to become set depend on whether the TPM is configured for center-aligned PWM (CPWMS=1). In the simplest mode, there is no modulus limit and the TPM is not in CPWMS=1 mode. In this case, the 16-bit timer counter counts from 0x0000 through 0xFFFF and overflows to 0x0000 on the next counting clock. TOF becomes set at the transition from 0xFFFF to 0x0000. When a modulus limit is set, TOF becomes set at the transition from the value set in the modulus register to 0x0000. When the TPM is in center-aligned PWM mode (CPWMS=1), the TOF flag gets set as the counter changes direction at the end of the count value set in the modulus register (that is, at the transition from the value set in the modulus register to the next lower count value). This corresponds to the end of a PWM period (the 0x0000 count value corresponds to the center of a period).

16.6.2.1.2 Center-Aligned PWM Case

When CPWMS=1, TOF gets set when the timer counter changes direction from up-counting to down-counting at the end of the terminal count (the value in the modulo register). In this case the TOF corresponds to the end of a PWM period.

16.6.2.2 Channel Event Interrupt Description

The meaning of channel interrupts depends on the channel's current mode (input-capture, output-compare, edge-aligned PWM, or center-aligned PWM).

16.6.2.2.1 Input Capture Events

When a channel is configured as an input capture channel, the ELSnB:ELSnA control bits select no edge (off), rising edges, falling edges or any edge as the edge which triggers an input capture event. When the selected edge is detected, the interrupt flag is set. The flag is cleared by the two-step sequence described in Section 16.6.2, "Description of Interrupt Operation."

16.6.2.2.2 Output Compare Events

When a channel is configured as an output compare channel, the interrupt flag is set each time the main timer counter matches the 16-bit value in the channel value register. The flag is cleared by the two-step sequence described Section 16.6.2, "Description of Interrupt Operation."

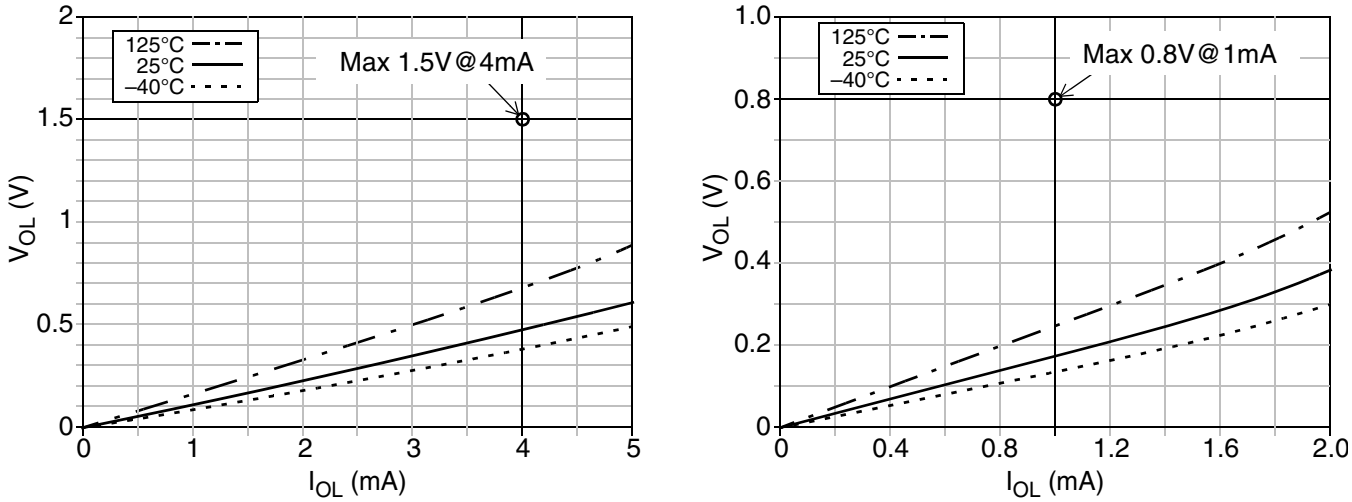
16.6.2.2.3 PWM End-of-Duty-Cycle Events

For channels configured for PWM operation there are two possibilities. When the channel is configured for edge-aligned PWM, the channel flag gets set when the timer counter matches the channel value register which marks the end of the active duty cycle period. When the channel is configured for center-aligned PWM, the timer count matches the channel value register twice during each PWM cycle. In this CPWM case, the channel flag is set at the start and at the end of the active duty cycle period which are the times when the timer counter matches the channel value register. The flag is cleared by the two-step sequence described Section 16.6.2, "Description of Interrupt Operation."

16.7 The Differences from TPM v2 to TPM v3

1. Write to TPMxCNTH:L registers (Section 16.3.2, "TPM-Counter Registers (TPMxCNTH:TPMxCNTL)) [SE110-TPM case 7]

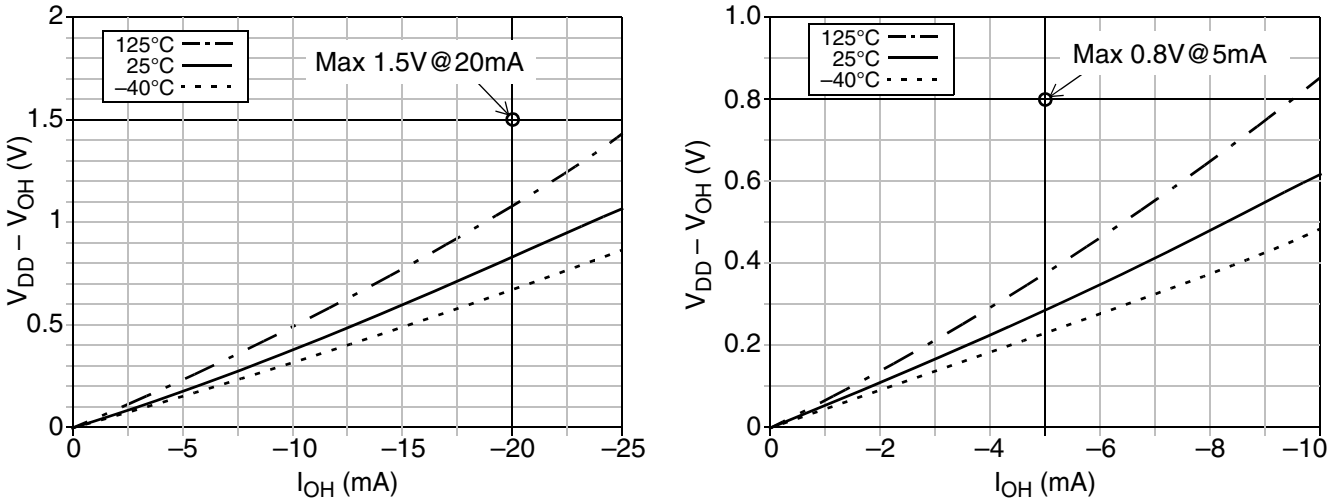
   Any write to TPMxCNTH or TPMxCNTL registers in TPM v3 clears the TPM counter (TPMxCNTH:L) and the prescaler counter. Instead, in the TPM v2 only the TPM counter is cleared in this case.
2. Read of TPMxCNTH:L registers (Section 16.3.2, "TPM-Counter Registers (TPMxCNTH:TPMxCNTL))
   - In TPM v3, any read of TPMxCNTH:L registers during BDM mode returns the value of the TPM counter that is frozen. In TPM v2, if only one byte of the TPMxCNTH:L registers was read before the BDM mode became active, then any read of TPMxCNTH:L registers during



a) V_{DD} = 5V, Low Drive

b) V_{DD} = 3V, Low Drive

Figure A-2. Typical V_{OL} vs I_{OL}, Low Drive Strength



a) V_{DD} = 5V, High Drive

b) V_{DD} = 3V, High Drive

Figure A-3. Typical $V_{DD} – V_{OH}$ vs I_{OH}, High Drive Strength

Table A-7. Supply Current Characteristics (continued)

Num	C	Parameter	Symbol	V_{DD} (V)	Typ[1]	Max[2]	Unit
5		Stop2 mode supply current					
	C	–40°C (C,M, & V suffix)	$S2I_{DD}$	5	0.9	–	µA
	P	25°C (All parts)			0.9	–	
	P[5]	85°C (C suffix only)			5.0	40.0	
	P[5]	105°C (V suffix only)			11.0	50.0	
	P[5]	125°C (M suffix only)			29.1	65.0	
	C	–40°C (C,M, & V suffix)		3	0.9	–	µA
	P	25°C (All parts)			0.9	–	
	P[5]	85°C (C suffix only)			4.2	35.0	
	P[5]	105°C (V suffix only)			8.8	45.0	
	P[5]	125°C (M suffix only)			25	60.0	
6	C	RTC adder to stop2 or stop3[6]	$S23I_{DDRTI}$	5	300	500	nA
				3	300	500	nA
7	C	LVD adder to stop3 (LVDE = LVDSE = 1)	$S3I_{DDLVD}$	5	110	180	µA
				3	90	160	µA
8	C	Adder to stop3 for oscillator enabled[7] (EREFSTEN =1)	$S3I_{DDOSC}$	5,3	5	8	µA

1 Typical values for specs 1, 2, 3, 6, 7, and 8 are based on characterization data at 25°C. See Figure A-5 through Figure A-7 for typical curves across temperature and voltage.

2 Max values in this column apply for the full operating temperature range of the device unless otherwise noted.

3 All modules except ADC active, ICS configured for FBELP, and does not include any dc loads on port pins

4 All modules except ADC active, ICS configured for FEI, and does not include any dc loads on port pins

5 Stop currents are tested in production for 25°C on all parts. Tests at other temperatures depend upon the part number suffix and maturity of the product. Freescale may eliminate a test insertion at a particular temperature from the production test flow once sufficient data has been collectd and is approved.

6 Most customers are expected to find that auto-wakeup from stop2 or stop3 can be used instead of the higher current wait mode.

7 Values given under the following conditions: low range operation (RANGE = 0) with a 32.768kHz crystal and low power mode (HGO = 0).